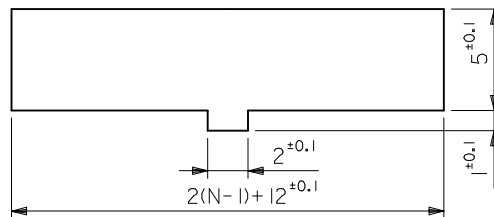


嵌合状態図
CROSS-SECTION OF MATED CONNECTORS



参考パネルスロット寸法
PANEL SLOT DIM.(REF.)
(パネル厚: 0.8~2.0)
(THICKNESS: 0.8-2.0)

無鉛
LEAD FREE

注記
NOTES

- 材料 MATERIAL
ウエハー: PBT,UL94V-0
WAFFER: PBT,UL94V-0
ピン: 黄銅, スズメッキ(φ0.5)
PIN: BRASS, TIN PLATED (0.5 SQUARE)
- 適合圧着ハウジング: 51090-***00
MATING CRIMP RECEPTACLE HOUSING: 51090-***00
- 適合圧接ハウジング: 52484-***1*
MATING IDT RECEPTACLE HOUSING: 52484-***1*
- △ B寸法のφから、隣接するピンのφまでの位置を示す。
THIS DIMENSION SHOWS SPACING BETWEEN CENTER OF PIN AND CENTER OF B DIMENSION.
- 本図は、6極を示す。
- 6 CIRCUIT VERSION IS SHOWN IN THIS DRAWING.
ハウジングは、パネル打抜き側から挿入すること。
INSERT HOUSING FROM PUNCH SIDE OF PANEL.
- 色 53358-***40: 自然色 (WHITE)
COLOR 53358-***42: 赤色 (RED)
53358-***43: 黄色 (YELLOW)
53358-***44: 青色 (BLUE)

2	42.1	35.3	33.3	32.1	28	53358-154*	15
1	40.1	33.3	31.3	30.1	26	-144*	14
2	38.1	31.3	29.3	28.1	24	-134*	13
1	36.1	29.3	27.3	26.1	22	-124*	12
2	34.1	27.3	25.3	24.1	20	-114*	11
1	32.1	25.3	23.3	22.1	18	-104*	10
2	30.1	23.3	21.3	20.1	16	-094*	9
1	28.1	21.3	19.3	18.1	14	-084*	8
2	26.1	19.3	17.3	16.1	12	-074*	7
1	24.1	17.3	15.3	14.1	10	-064*	6
2	22.1	15.3	13.3	12.1	8	-054*	5
1	20.1	13.3	11.3	10.1	6	-044*	4
2	18.1	11.3	9.3	8.1	4	-034*	3
1	16.1	9.3	7.3	6.1	2	53358-024*	2
F	E	D	C	B	A	ENG. NO.	CKT.

REVISED EC NO: J2015-0419 DR: WAKAMATSUYAMA 2014/09/26 CHKD: KASAKAWA 2014/09/29 APPR: NUKITA 2014/11/11	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC		THIRD ANGLE PROJECTION	
	10 UNDER	±0.2	DRAWN BY SSHIBATA	DATE 2012/11/21	TITLE 2.0 WIRE TO WIRE CONN. PANEL MOUNT WAFER ASSY				
	10 OVER 30 UNDER	±0.25	CHECKED BY JMIYAZAWA	DATE 2012/11/21					
	30 OVER	±0.3	APPROVED BY YOITO	DATE 2012/11/21					
ANGULAR ±3 °		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. SEE CHART		DOCUMENT NO. SD-53358-001		SHEET NO. 1 OF 1	
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									